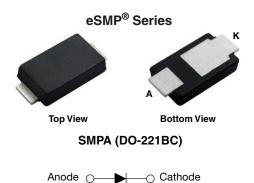
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Vishay General Semiconductor

Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



LINKS TO ADDITIONAL RESOURCES

\sim	
2	
3D M	odels

PRIMARY CHARACTERISTICS			
I _{F(AV)}	8.0 A		
V _{RRM}	100 V		
I _{FSM}	100 A		
V_F at I_F = 8.0 A (T_J = 125 °C)	0.6 V		
T _J max.	175 °C		
Package	SMPA (DO-221BC)		
Circuit configuration	Single		

FEATURES

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial and automotive applications.

MECHANICAL DATA

Case: SMPA (DO-221BC) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V8PAM103	UNIT	
Device marking code		8M13		
Maximum repetitive peak reverse voltage	V _{RRM}	100	V	
Maximum DC forward current	I _{F(AV)} ⁽¹⁾	8.0	Α	
	I _{F(AV)} ⁽²⁾	3.0		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	100	A	
Operating junction temperature range	T _J ⁽³⁾	-40 to +175	°C	
Storage temperature range	T _{STG}	-55 to +175	°C	

Notes

⁽¹⁾ Units mounted on 3 cm x 3 cm aluminum PCB

(2) Free air, mounted on recommended copper pad area, 2 oz., FR4 PCB

 $^{(3)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: dP_D/dT_J < 1/R_{0JA}







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ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted)							
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT	
Instantaneous forward voltage	I _F = 4.0 A	T _J = 25 °C	V _E (1)	0.57	-	V	
	I _F = 8.0 A			0.68	0.75		
	I _F = 4.0 A	- T _J = 125 °C		VF ()	0.5	-	l v
	I _F = 8.0 A			0.6	0.66		
Reverse current	V _R = 70 V	$T_{\rm J} = 25 ^{\circ}{\rm C}$	I _R (2)	0.002	-	mA	
	v _R = 70 v	T _J = 25 °C T _J = 125 °C		1.5	-		
	V _R = 100 V	T _J = 25 °C T _J = 125 °C		-	0.17	IIIA	
	v _R = 100 v	T _J = 125 °C		3	12		
Typical junction capacitance	4.0 V, 1 M⊦	4.0 V, 1 MHz		980	-	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 5 ms

THERMAL CHARACTERISTICS ($T_A = 25$ °C unless otherwise specified)				
PARAMETER	V8PAM103	UNIT		
Typical thermal resistance	R _{0JA} (1)(2)	100	°C/W	
	R _{0JM} ⁽³⁾	5	0/11	

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

 $^{(2)}$ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

 $^{(3)}$ Units mounted on 3 cm x 3 cm aluminum PCB; thermal resistance $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V8PAM103-M3/H	0.032	Н	3500	7" diameter plastic tape and reel	
V8PAM103-M3/I	0.032	I	14 000	13" diameter plastic tape and reel	
V8PAM103HM3/H ⁽¹⁾	0.032	Н	3500	7" diameter plastic tape and reel	
V8PAM103HM3/I ⁽¹⁾	0.032	l	14 000	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise specified)

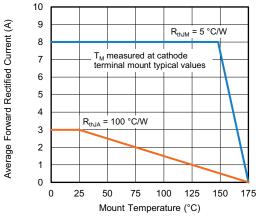


Fig. 1 - Maximum Forward Current Derating Curve

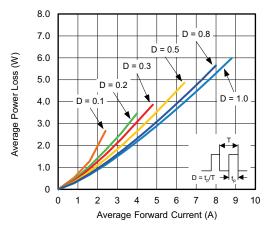


Fig. 2 - Forward Power Loss Characteristics

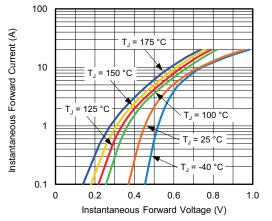


Fig. 3 - Typical Instantaneous Forward Characteristics

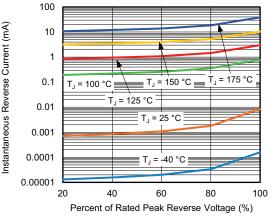
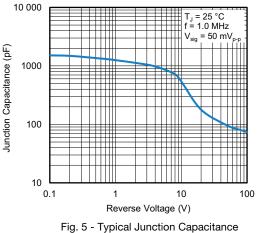


Fig. 4 - Typical Reverse Leakage Characteristics





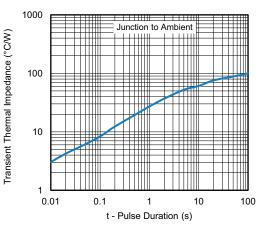


Fig. 6 - Typical Transient Thermal Impedance

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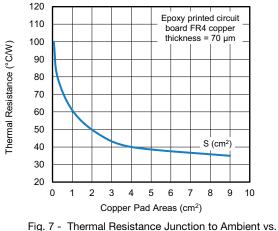
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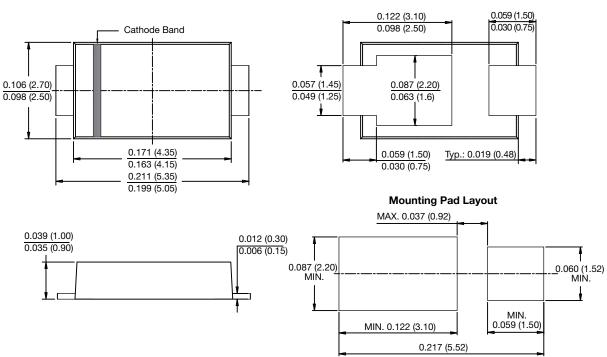


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Copper Pad Areas

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



SMPA (DO-221BC)



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